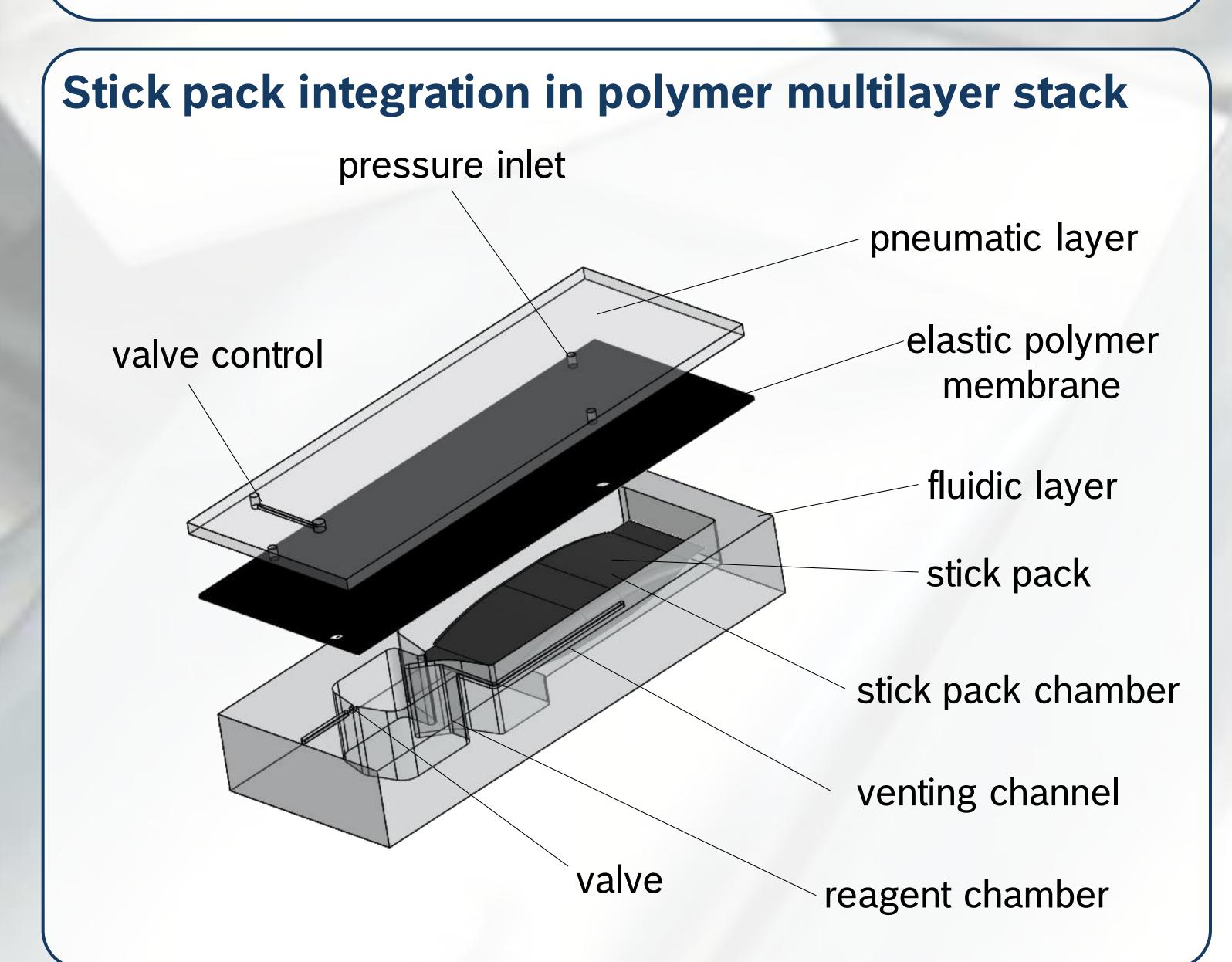
Long-term on-chip storage and release of liquid reagents for diagnostic lab-on-a-chip applications

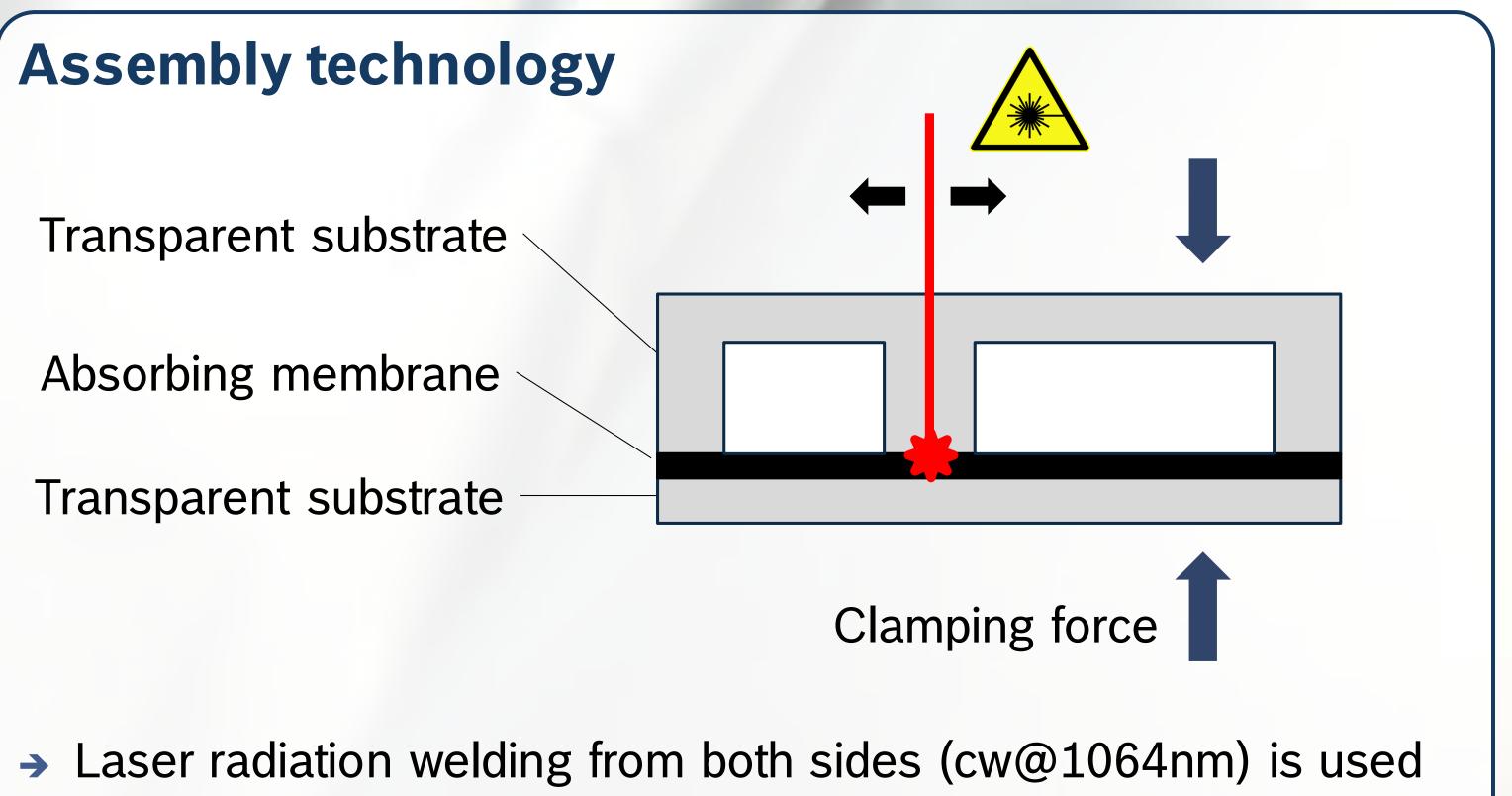
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Introduction

- → On-chip reagent storage enables massive advantages for diagnostic lab-on-a-chip (LoC) applications.
- → Here, we present a low-cost, polymer multilayer stack with integrated stickpacks for long-term storage of liquid reagents at room temperature. Reagent release is realized by pushing an elastomer membrane against the stick pack through pneumatic pressure.
- → Compared to existing solutions [1-2] this storage concept can be implemented into pressure-driven LoC-devices [3].

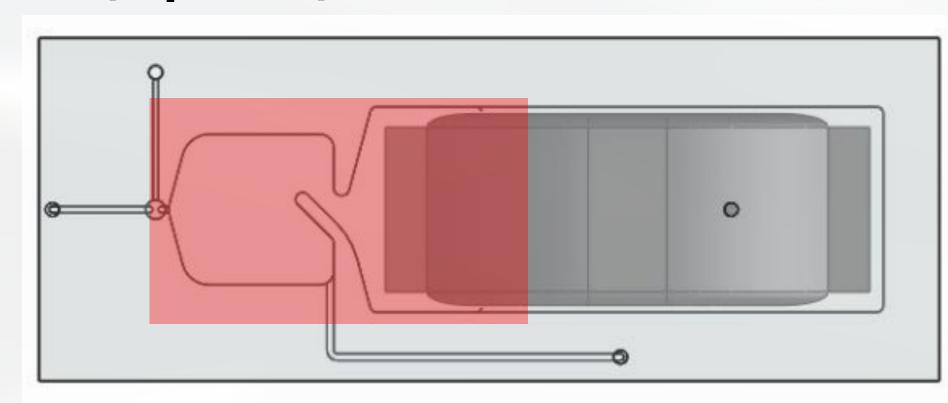




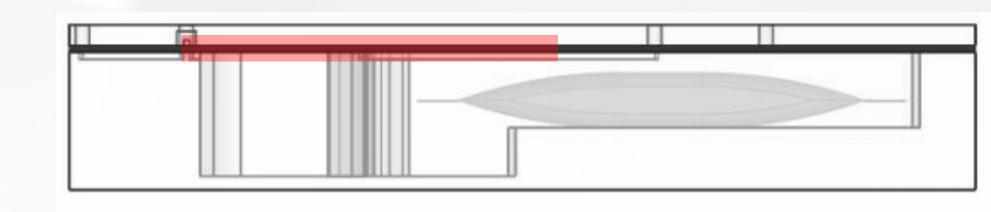
for joining polymer multilayer stack.

Operation mode of reagent release

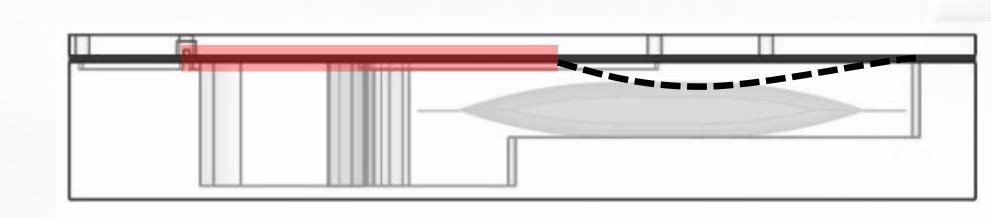
Initial state (top view)



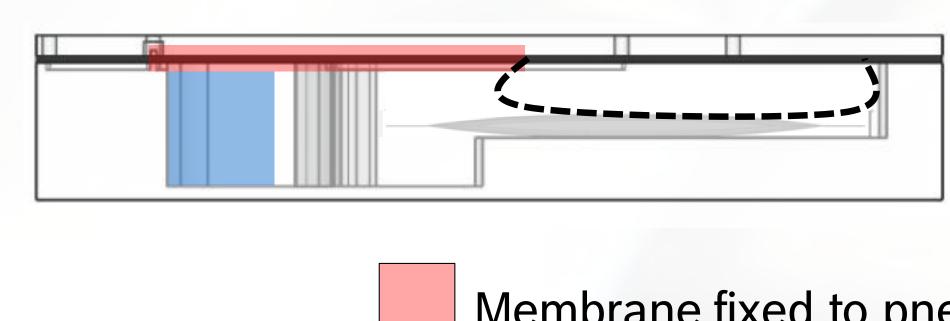
→ Initial state (side view)



→ Pneumatic actuation of membrane



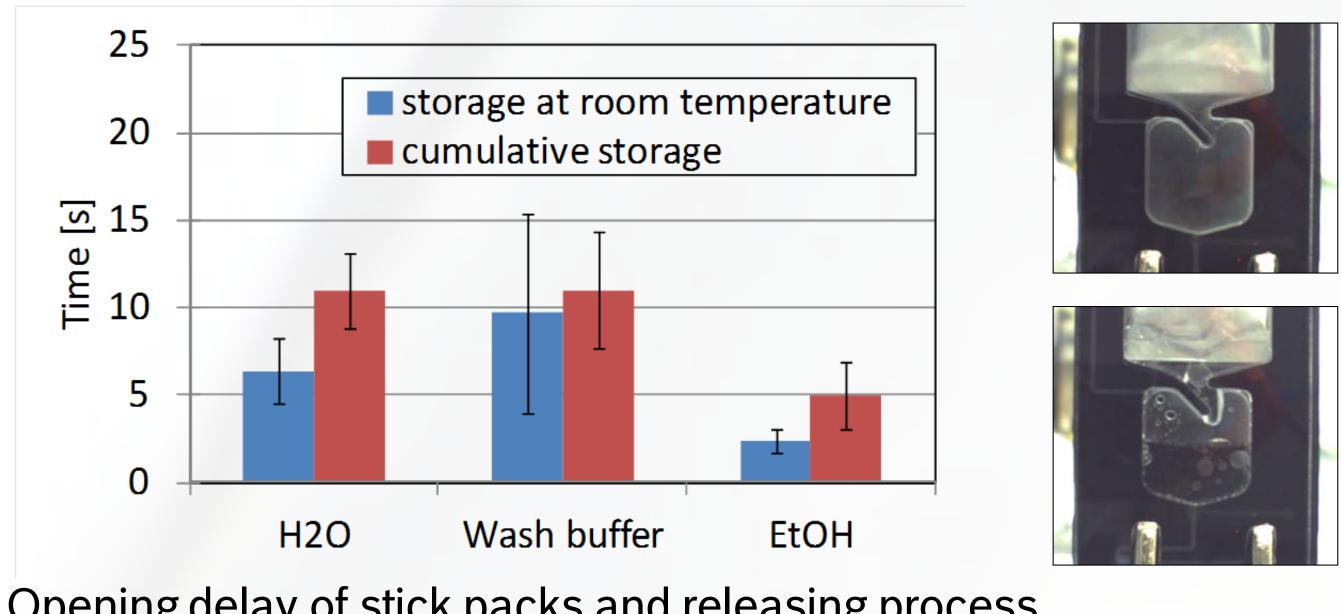
→ Delamination of peel seam and reagent release



Membrane fixed to pneumatic layer

Results

- Cumulative storage of stick packs including cycles of high thermal stress generates reagent losses below 0,1%.
- → A repeatable pressure-driven opening of stick packs could be demonstrated.
- → Stick packs filled with H₂O, wash buffer and EtOH show opening delays below 30s for RT and cumulative storage.



Opening delay of stick packs and releasing process

Conclusions

This concept enables long-term on-chip storage of liquid reagents at room temperature and reagent release on demand.

- → Long-term storage: Minimal reagent loss for highly volatile reagents containing EtOH
- > Repeatable release: Pressure-driven opening of stick packs even after accelerated aging is statistically proven
- → Easy implementation: Transferable into pressure-driven LoC platforms with great freedom of placement
- [1] T. van Oordt et al., Lab Chip 15 (2013) 2851-3138
- [2] J. Hoffmann et al., Lab Chip 10 (2010) 1480-1484
- [3] J. Rupp et al., Journal Micro. and Elect. Pack. 4 (2009) 1551-4897

